## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applic	ation of:		HAGELIN et al.	Confirmation	on No.:	To be assigned
Serial 1	No.:		To be assigned	Art Unit:	2872	
Filed:			July 25, 2003	Examiner:	James Phan	ı
For:			Apparatus and Method for Optical Raster-Scanning in a Micromechanical System	Attorney D	ocket No.:	9785-0008-999
	,		INFORMATION DISCLOSUI	RE STATEM	MENT	
P.O. B	issioner ox 1450 ndria, V <i>A</i>	)	Patents 313-1450			
Sir:						
subject	ed certai: t U.S. pa	n in: tent	formation which the Examiner may con application. It is requested that the Ex to the examination of the application.	nsider materi	al to the exan	nination of the
1.	Enclos	ures	accompanying this Information Disclo	sure Stateme	ent are:	
	la.	$\boxtimes$	A list of all patents, publications, appropriate consideration by the office.	lications, or o	other informa	tion submitted for
	1b.	A 1	egible copy of:			
			Each U.S. patent application publication	ion and U.S.	and foreign p	patent;
			Each publication or that portion which	h caused it to	be listed on	the PTO-1449;
		the	For each cited pending U.S. application claims, and any drawing of the applications it to be listed on the PTO-1449 income.	ation, or port	ion of the app	olication which
			all other information or portion which	caused it to	be listed on t	he PTO-1449.
	1c.		An English language copy of search rapplication or PCT International Sear		a counterpa	rt foreign
	1d.		Explanations of relevancy (ATTACH abstracts of the non-English language			nglish language
2.	$\boxtimes$	Th	is Information Disclosure Statement is Within three months of the filing date continued prosecution application und	of a national		
			Within three months of the date of en §1.491 in an international application		ional stage as	s set forth in

		Before the mailing of the first Office action on the merits;
		☐ Before the mailing of a first Office action after the filing of a request for continued examination under §1.114.
3.		This Information Disclosure Statement is filed under 37 C.F.R. §1.97(c) after the period specified in 37 C.F.R. §1.97(b), but before the mailing date of any of a final action under 37 C.F.R. §1.113, a notice of allowance under 37 C.F.R. §1.311 or an action that otherwise closes prosecution in the application.
		(Check either Item 3a or 3b)
	3a.	The Certification Statement in Item 5 below is applicable. Accordingly, no fee is required.
	3b.	☐ The \$180.00 fee set forth in 37 C.F.R. §1.17(p) in accordance with 37 C.F.R. §1.97(c) is: ☐ enclosed
		to be charged to Pennie & Edmonds LLP Deposit Account No. 16-1150.
		(Item 3b to be checked if any reference known for more than 3 months)
4.		This Information Disclosure Statement is filed under 37 C.F.R. §1.97(d) after the period specified in 37 C.F.R. §1.97(c), but on or before the date of payment of the issue fee.
		The \$180.00 fee set forth in 37 C.F.R. §1.17(p) is:  conclused.  to be charged to Pennie & Edmonds LLP Deposit Account No. 16-1150.
	The C	Certification Statement in Item 5 below is applicable.
5.		Certification Statement (applicable if Item 3a or Item 4 is checked)
		(Check either Item 5a or 5b)
	5a.	In accordance with 37 C.F.R. §1.97(e)(1), it is certified that each item of information contained in this Information Disclosure Statement was first cited in a communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this Information Disclosure Statement.
	5b.	In accordance with 37 C.F.R. §1.97(e)(2), it is certified that no item of information contained in this Information Disclosure Statement was cited in a communication from a foreign patent office in a counterpart foreign application and, to the knowledge of the undersigned after making reasonable inquiry, was known by any individual designated in 37 C.F.R. §1.56(c) more than three months prior to the filing of this Information Disclosure Statement.
6.	$\boxtimes$	This application is a continuation application under 37 C.F.R. §1.60 or §1.53(b) or (d).
		(Check appropriate Items 6a, 6b and/or 6c)
	6a.	A Petition to Withdraw from issue under 37 C.F.R. §1.313(b)(5) is concurrently filed herewith.

	6b.	Copies of publications listed on Form PTO-1449 from prior application Serial No. 10/052,148, filed on January 16, 2002, of which this application claims priority under 35 U.S.C. §120, are not being submitted pursuant to 37 C.F.R. §1.98(d).
	6c.	Copies of the publications listed on Form PTO-1449 were not previously cited in prior application Serial No. , filed on , and are provided herewith.
7.		This is a Supplemental Information Disclosure Statement. (Check Item 7a)
	7a.	This Supplemental Information Disclosure Statement under 37 C.F.R. §1.97(f) supplements the Information Disclosure Statement filed on . A bona fide attempt was made to comply with 37 C.F.R. §1.98, but inadvertent omissions were made. These omissions have been corrected herein. Accordingly, additional time is requested so that this Supplemental Information Disclosure Statement can be considered as if properly filed on .
8.		In accordance with 37 C.F.R. §1.98, a concise explanation of what is presently understood to be the relevance of each non-English language publication is:
		( Check Item 8a, 8b, or 8c)
	8a.	satisfied because all non-English language publications were cited on the enclosed English language copy of the PCT International Search Report or the search report from a counterpart foreign application indicating the degree of relevance found by the foreign office.
	8b.	set forth in the application.
	8c.	enclosed as an attachment hereto.
9.	$\boxtimes$	The Commissioner is authorized to charge any additional fee required or credit any overpayment for this Information Disclosure Statement and/or Petition to Pennie & Edmonds LLP Deposit Account No. 16-1150.
10.		No admission is made that the information cited in this Statement is, or is considered to be, material to patentability nor a representation that a search has been made (othe than a search report of a foreign counterpart application or PCT International Search Report if submitted herewith). 37 C.F.R. §§1.97(g) and (h).
Date:	July 2	Respectfully submitted,  25, 2003  Respectfully submitted,  24,615  Francis E. Morris for Gary S. Williams PENNIE & EDMONDS LLP 3300 Hillview Avenue Palo Alto, California 94304 (650) 493-4935

## LIST OF REFERENCES CITED BY APPLICANT

(Use several sheets if necessary)

ATTY, DOCKET NO. 9875-0008-999	APPLICATION NO.  To be assigned
APPLICANT	
Hagelin <i>et al</i> .	
FILING DATE	GROUP
T1 25 2002	0070

			July 25, 2	003	.2872		
		U	S. PATENT DOCUMENTS				
EXAMINER INITIAL	DÖCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING IF APPR	G DATE IOPRIAT
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	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANS	LATION
		-				YES	NO
			Including Author, Title, Date, Pertinent P				
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	DATE CONSIDERED